

FORACAM: A VERY PRECISE IMAGING METHOD FOR THERMAL METAL PROPERTIES CHARACTERIZATION AND FLAW DETECTION



EDEVIS GMBH
STUTT GART
GERMANY

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PRODUCTS



OTvis Optical excited Lockin-Thermography



PTvis Pulse Thermography



LTvis Laser Thermography



UTvis Ultrasound Thermography



ITvis Inductive excited Thermography



SHEAROVIS Laser-Shearography



ForaCAM Photothermal radiometry

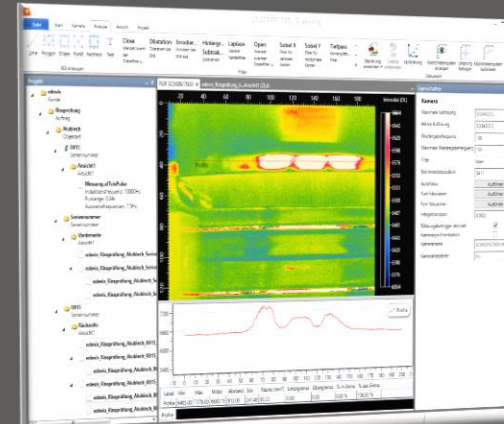
NEW



LITE Electro-Testing

NEW

Software DisplayIMG 6
Image processing and excitation
controller / real-time



Infrared cameras
Cooled FPA and
Micro-bolometer



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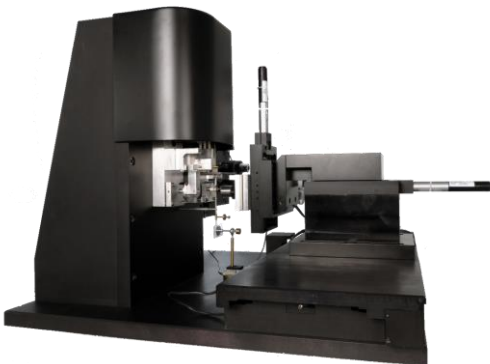
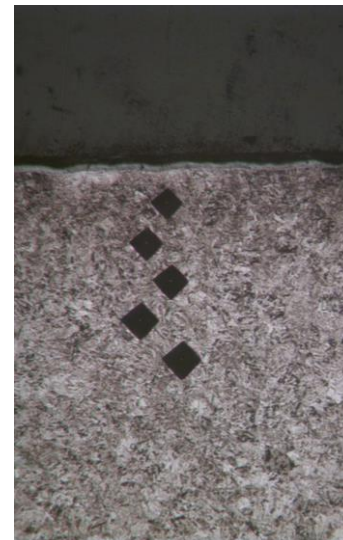
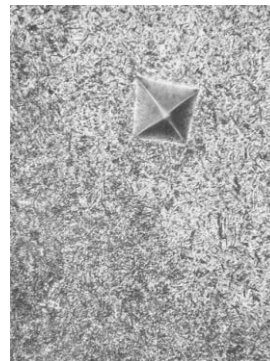
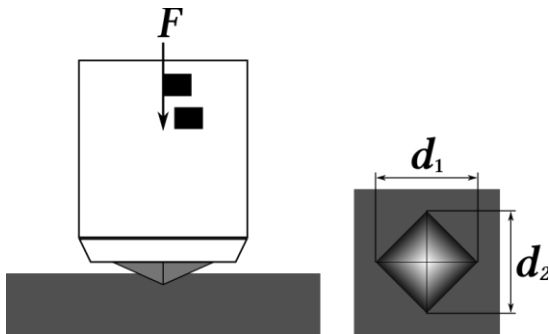
APPLICATIONS



Measurement of hardness /hardness profile

State of the art: indentation (Rockwell, Vickers, ...)

- ▶ Time-consuming
- ▶ Destructive test

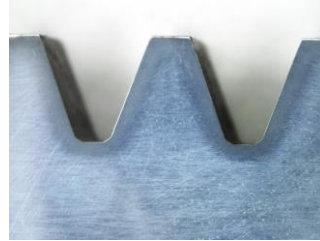


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APPLICATIONS



Measurement of carbonized depth

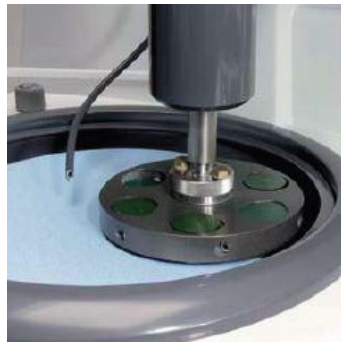


State of the art: metallography

- ▶ Time-consuming
- ▶ Destructive test



sampling



embedding, milling, polishing, etching



microscopy

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APPLICATIONS



Detection of grinding burn

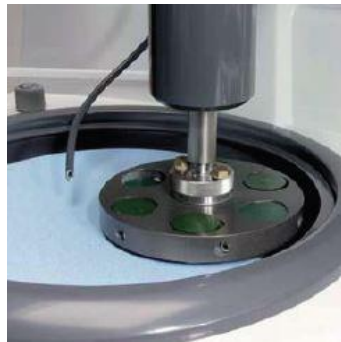


State of the art: metallography

- ▶ Time-consuming
- ▶ Destructive test



sampling



embedding, milling, polishing, etching



microscopy

TASK: INCREASE COST-EFFICIENCY

- ▶ Avoid sample preparation: save time to notice weak hardening process much earlier



- ▶ Non-destructive test: test object can still be used

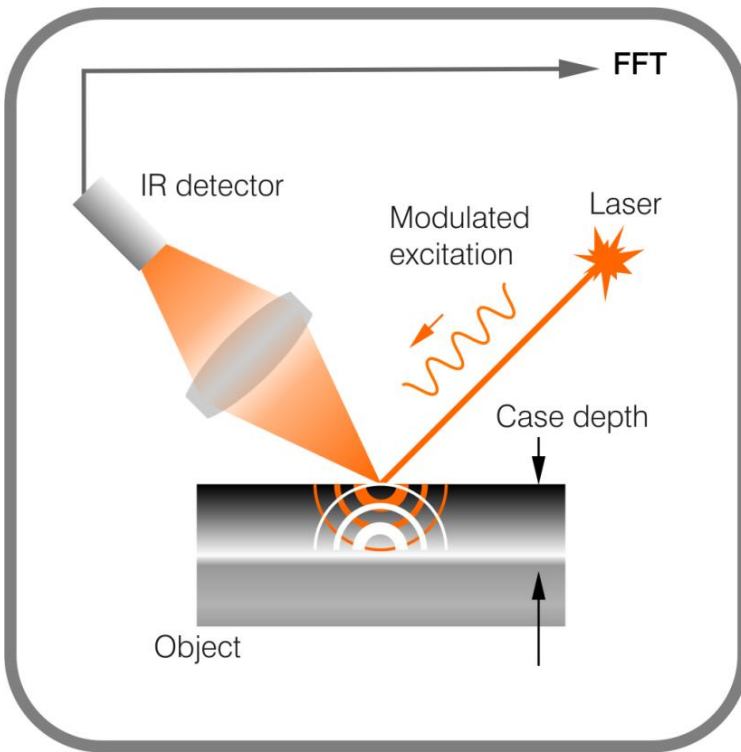


- ▶ Inline measurements: 100% inspection instead of samples, avoid rejection of whole batches



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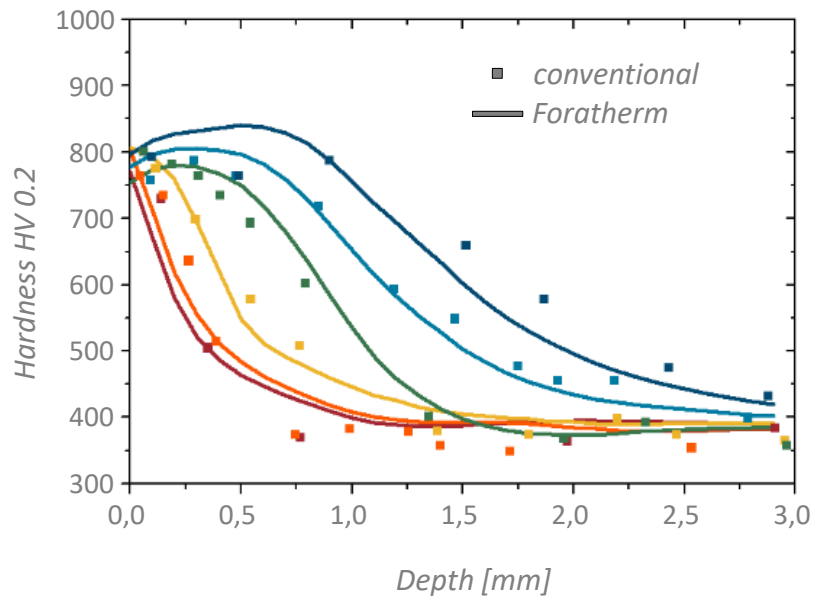
SOLUTION: FORATHERM PHOTOTHERMAL RADIOMETRY



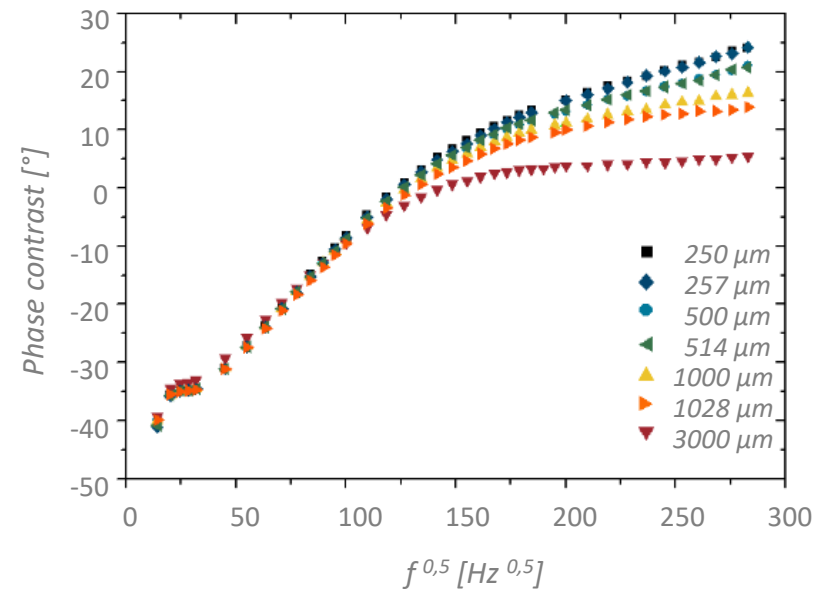
Determination / detection of

- ▶ layer thicknesses
- ▶ case hardness depths
- ▶ nitriding depths
- ▶ hardness profiles
- ▶ porosity contents
- ▶ grinding burn
- ▶ hidden corrosion

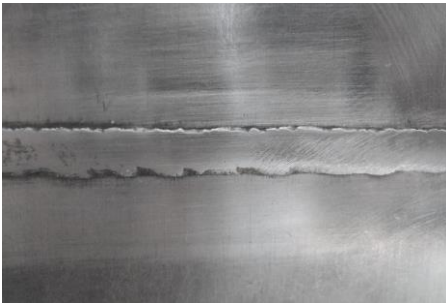
Non-contact determination of hardness profile
(after calibration with reference body)



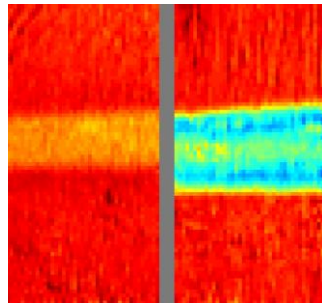
Non-contact determination of Invar layer thickness on silicon substrate



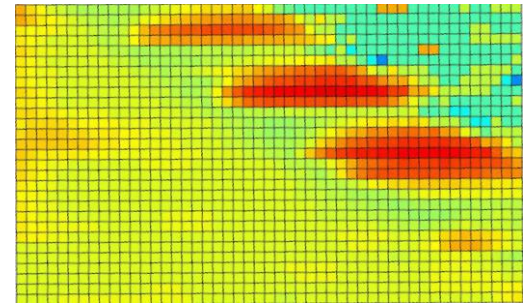
FORATHERM: EXAMPLES WITH SCANNING



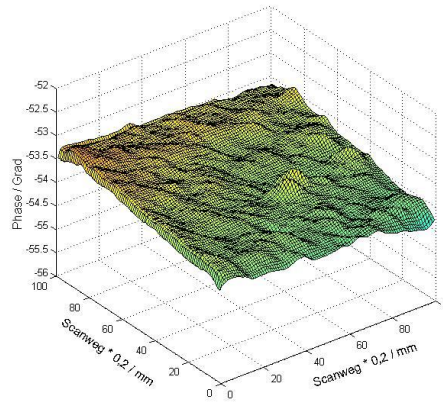
Welding seam



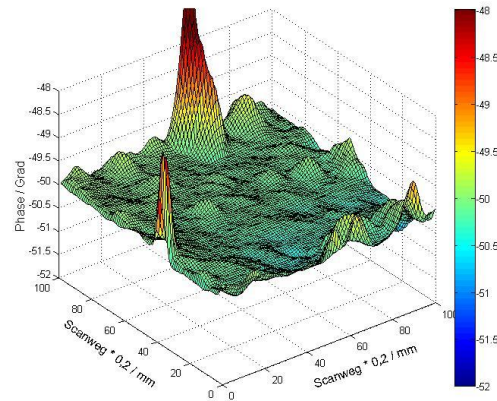
annealed / not annealed



Grinding burn



without grinding burn



with grinding burn



Advantages

- ▶ Non-contact
- ▶ Non-destructive
- ▶ Inline-testing is possible
- ▶ Faster than materialographic analysis

Drawbacks

- ▶ Detector size 1 Pixel:
Imaging requires time
consuming scanning of sample
or sensor head

1 PIXEL IS ENOUGH?



Why not using an infrared camera?

- ▶ Metals have a high thermal diffusivity
Very high frame rates needed ✓
- ▶ Layers like grinding burn are very thin:
Extremely high frame rates needed ✓
- ▶ Signals levels are very small:
Perfect temporal synchronization needed



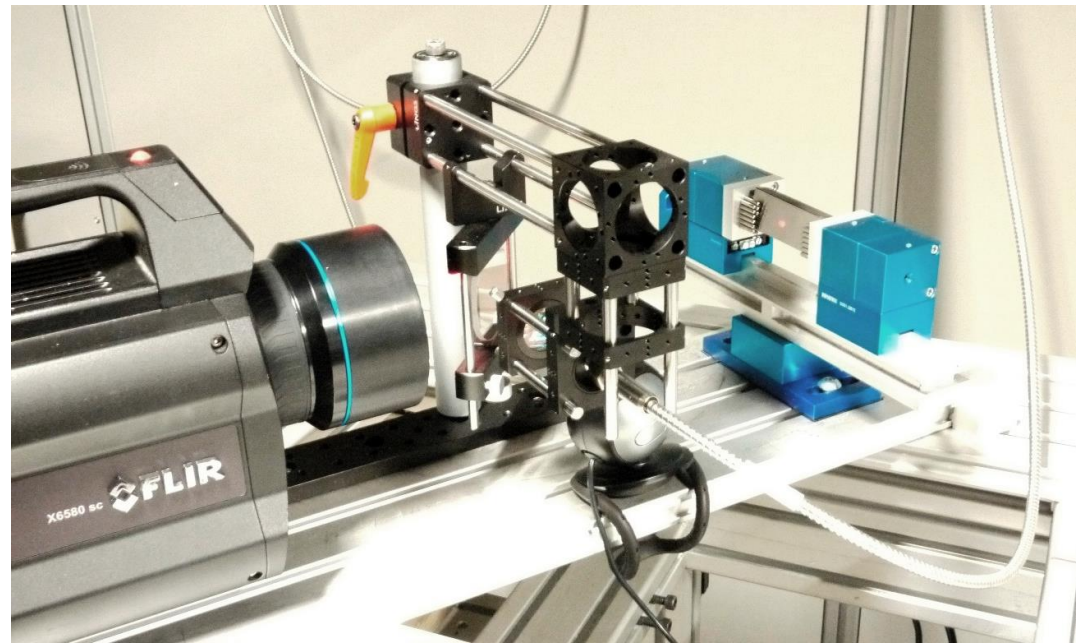
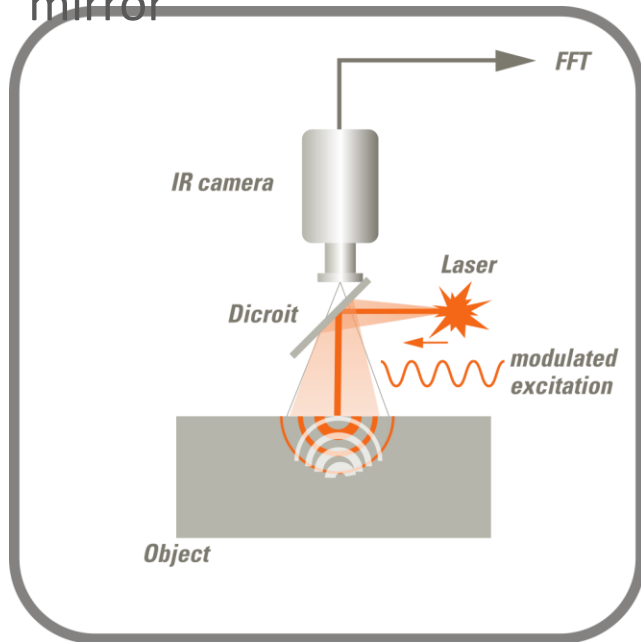
- ▶ FLIR X8500sc,
180Hz
- ▶ Subwindowing
- ▶ FLIR X6900sc,
1003Hz
- ▶ Subwindowing
- ▶ Subsampling
- ▶ edevis signal
generator ESG
- ▶ edevis software
DisplayIMG

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FORACAM SETUP



Collinear setup of IR camera and excitation laser with dichroitic mirror



Advantages:

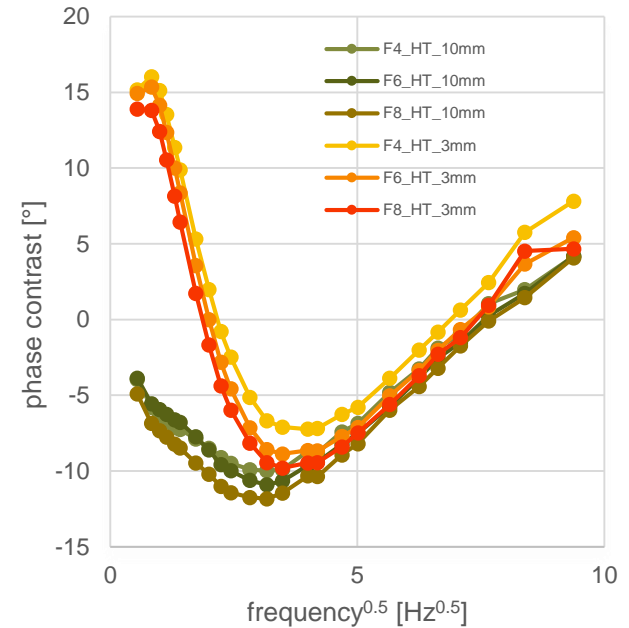
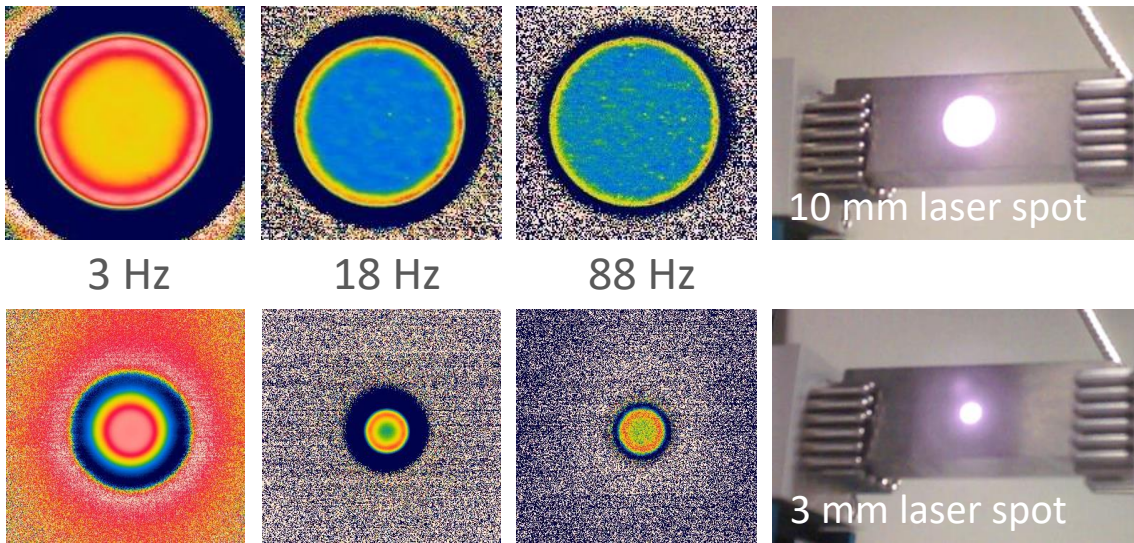
- ▶ Measurement spot position independent from working distance
- ▶ No geometrical constraints between camera & lens and laser excitation

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FORACAM



Case hardened specimen, tested at different modulation frequencies



10 mm spot size: phase signal 1D heat flow ->

lower phase contrast

3 mm spot size: phase signal influenced by 3D heat flow ->

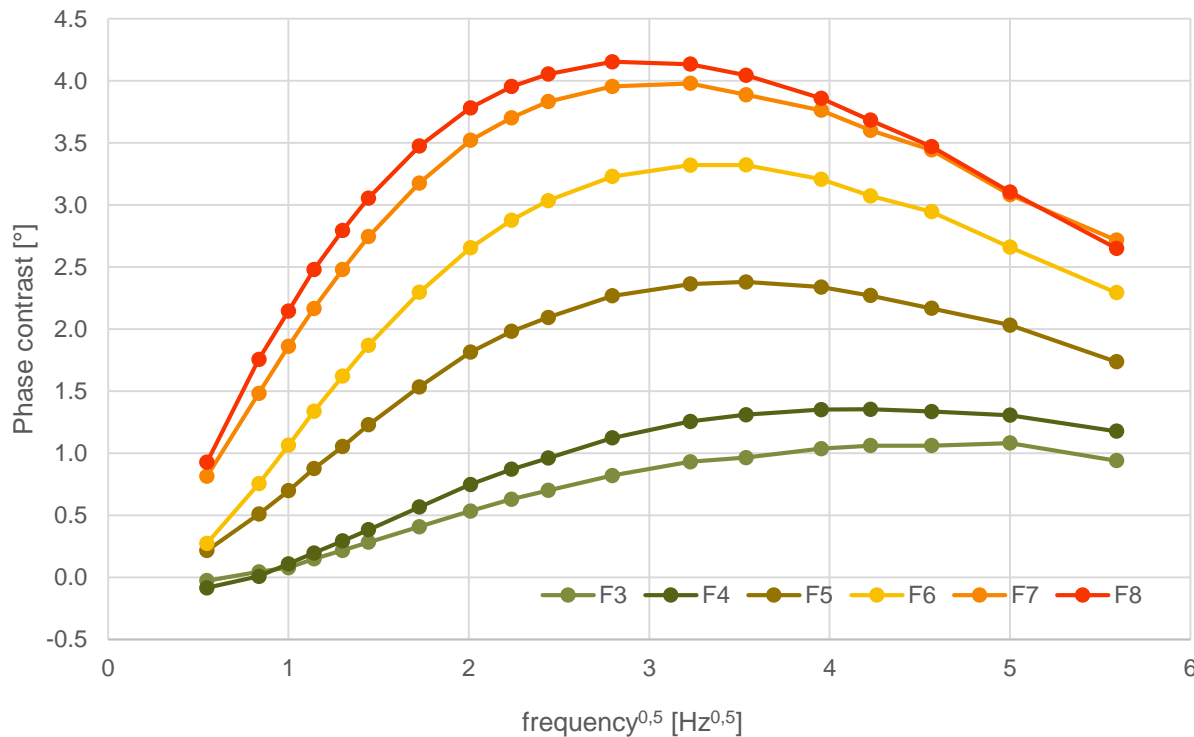
higher phase contrast
due to lateral heat flux effects

⇒ Spot size should be optimized

⇒ For imaging, array of laser spots can be used



Case hardening depths of 16MnCr5 samples between 0.3 and 2.0 mm



CHD:
F3 0.3 mm
F4 0.5 mm
F5 0.8 mm
F6 1.0 mm
F7 1.3 mm
F8 2.0 mm

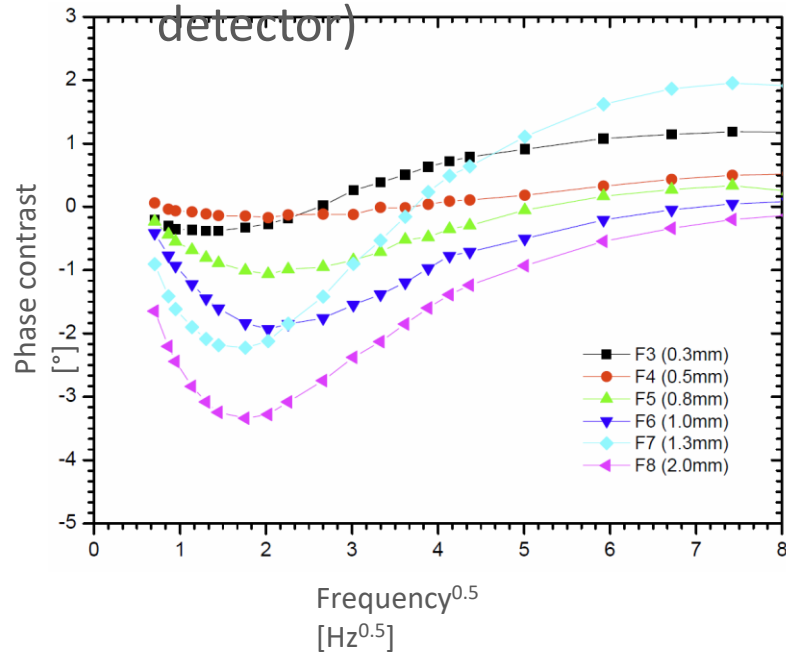
Strong signal change -> CHD can be determined quantitatively (requires calibration)

FORACAM VS FORATHERM

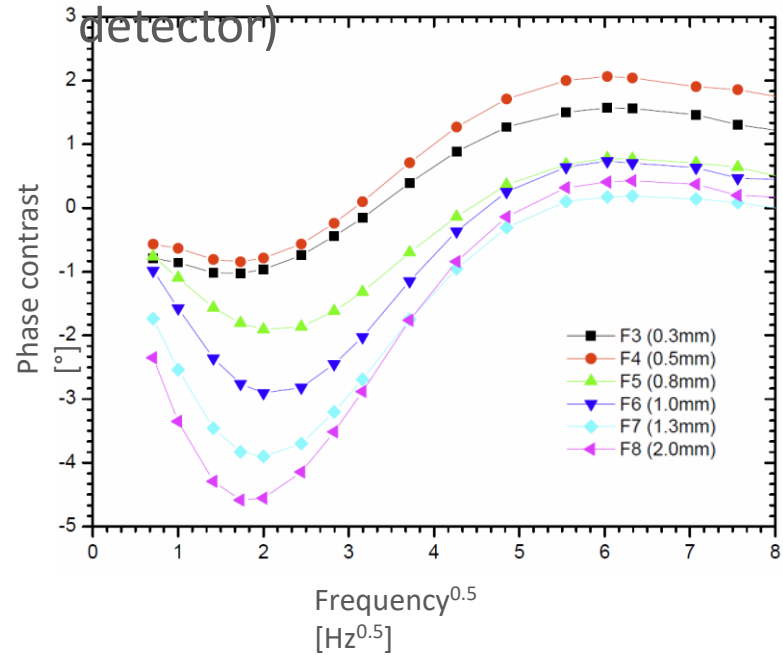


Case hardening depths of 16MnCr5 samples between 0.3 and 2.0 mm

ForaTherm (1 point detector)



ForaCAM (focal plane array detector)



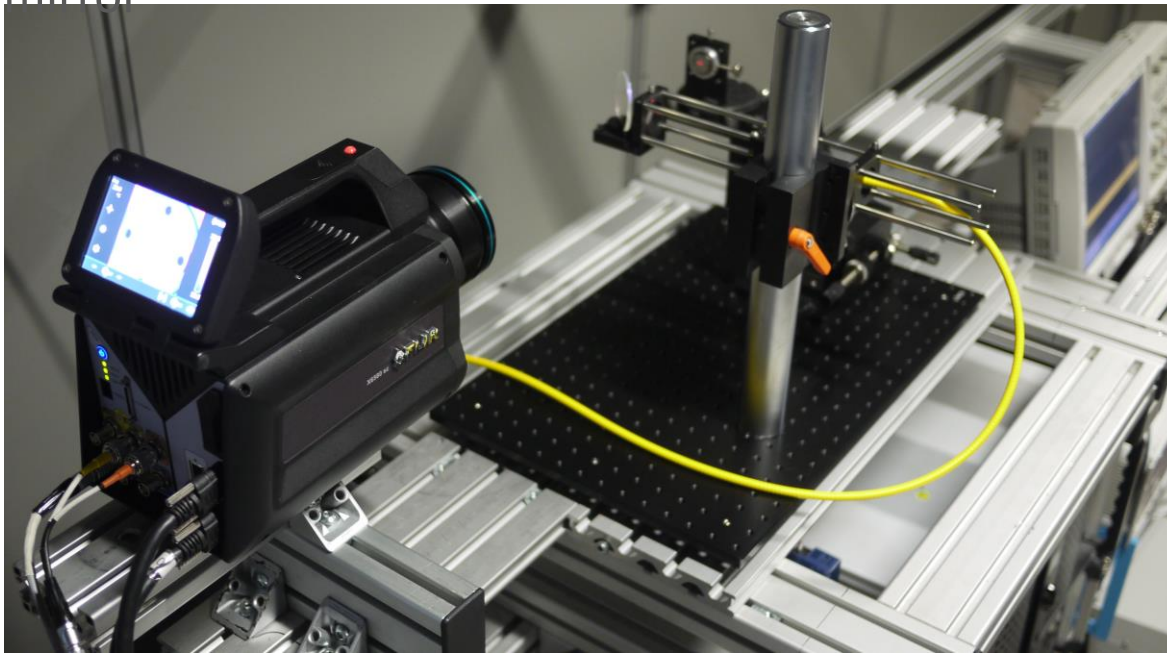
ForaCAM is even more sensitive!

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FORACAM GRINDING BURN DETECTION



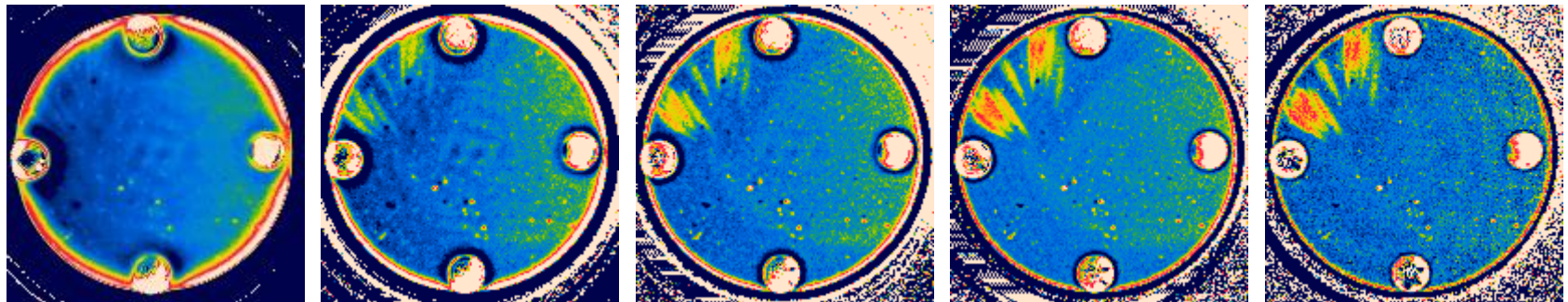
Collinear setup of IR camera and excitation laser with dichroitic mirror



Frame rate 900 Hz
Subwindow 160 x 160 pixel
IFOV 125 μm
Measurement field 20 x 20 mm^2
Laser power 200 W

FORACAM GRINDING BURN DETECTION

Foracam Specimen 1 (measurement duration: 30s per image)



10 Hz

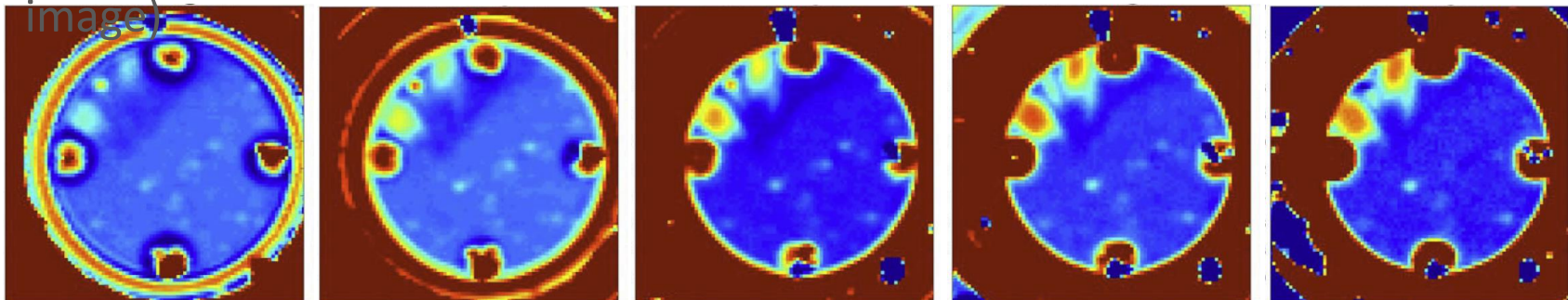
39 Hz

82 Hz

150
Hz

225 Hz

Foratherm Specimen 1 (scanned, measurement duration ca. 60min per image)



23 Hz

65 Hz

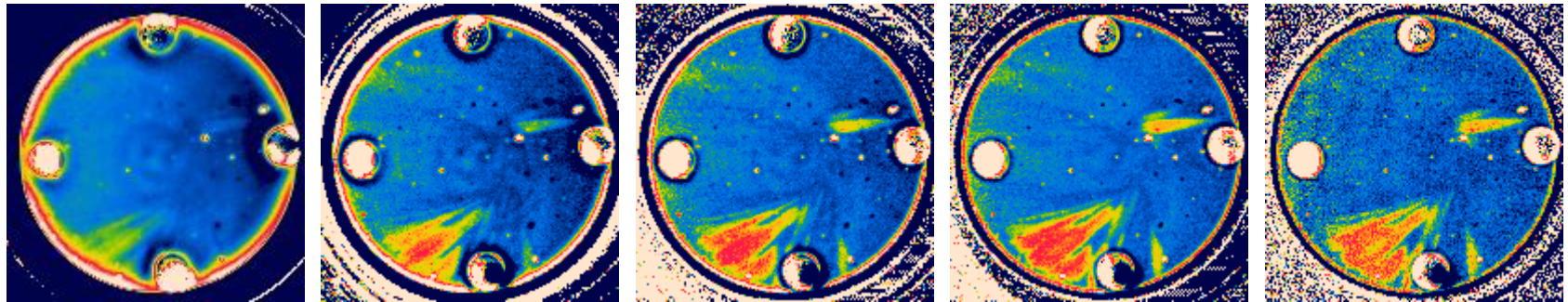
205
Hz

405
Hz

905
Hz

FORACAM GRINDING BURN DETECTION

Foracam Specimen 2 (measurement duration: 30s per image)



10 Hz

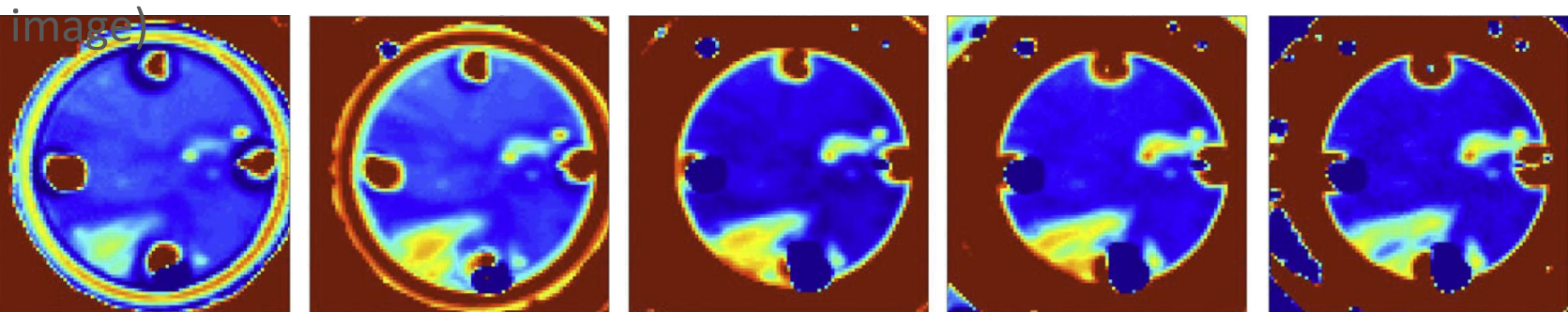
39 Hz

82 Hz

150
Hz

225 Hz

Foratherm Specimen 2 (scanned, measurement duration ca. 20min per



23 Hz

65 Hz

205
Hz

405
Hz

905
Hz

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FORACAM SYSTEM COMPONENTS



Sensor head with dicroit and IR camera: Foracam



Synchronization: ESG



Software: DisplayImg



Laser: LTvis 250 NT



Optional: LTvis cabinet



SUMMARY

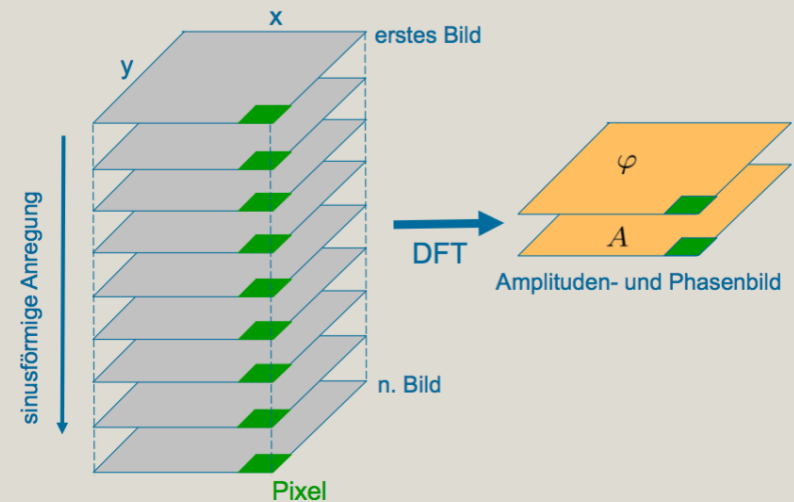
- ▶ After a calibration, metallography can often be replaced
- ▶ For one spot measurements Foratherm is suited perfectly
- ▶ Imaging photothermal radiometry is now possible with highspeed IR cameras and edervis hard- and software
- ▶ Both methods reduce costs and increase reliability
- ▶ Lab systems and industrial test stands available



**LOCKIN-THERMOGRAPHY
FOR INVESTIGATION OF ELECTRONIC
COMPONENTS**

WHY LOCK-IN?

- **Lock-In Thermography** is well known and widely used in active thermography. Typical applications are non-destructive material testing and material characterization
- This powerful technique can help to see **smallest temperature differences** in electronic components with **increased contrast** and **improved spatial resolution** avoiding thermal undesired dissipation effects
- The technique can be combined with current FLIR cameras such as FLIR A655sc, FLIR A6750sc, or T1030sc v



SYSTEM CONFIGURATION

FLIR R&D Camera



Standard Core i7 computer



Edevis signal generator and power switch



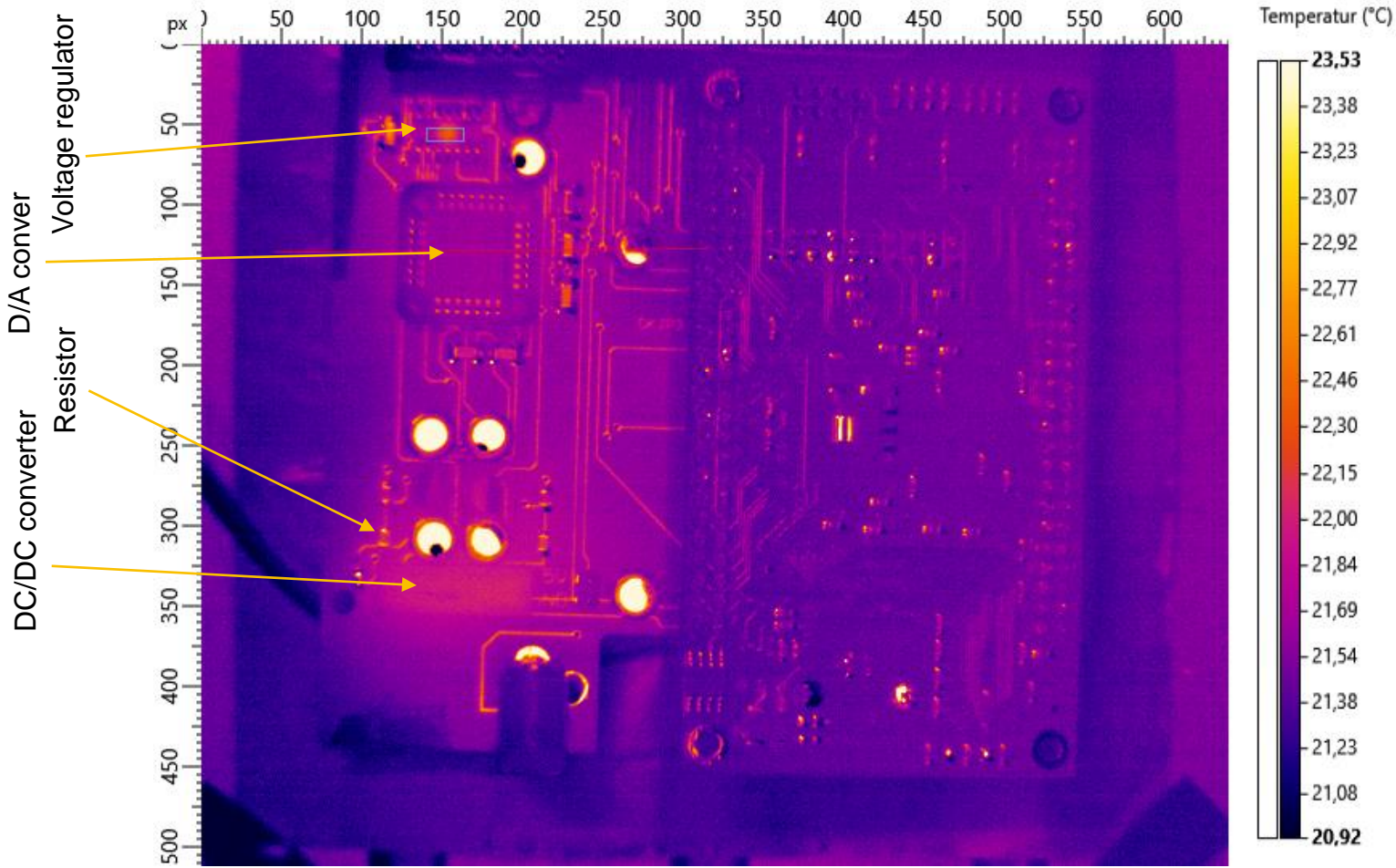
Standard power supply



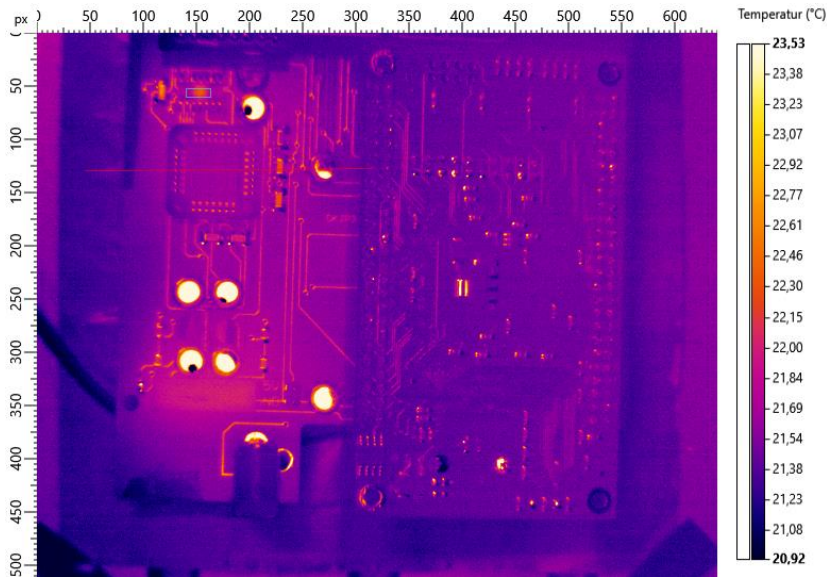
TEMPERATURE IMAGE



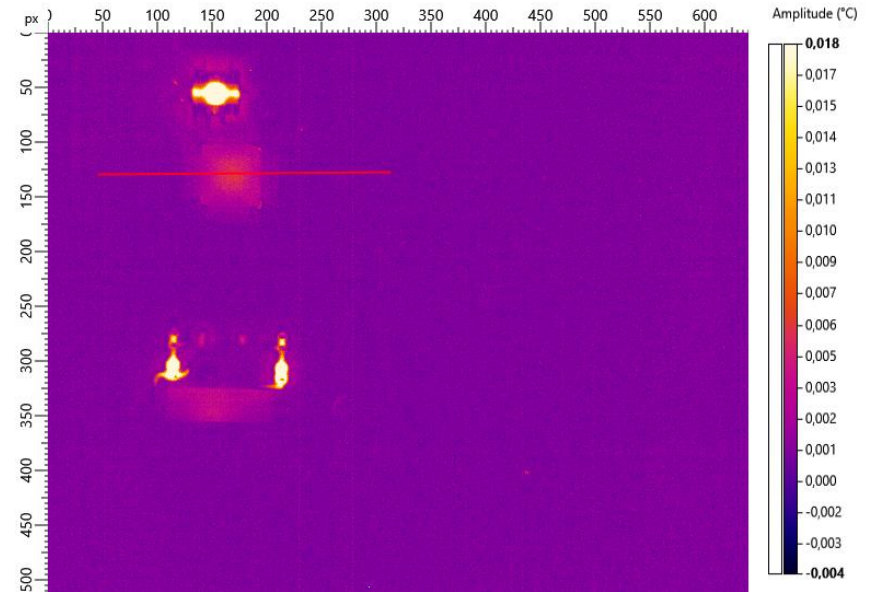
Dissipation Hotspots



TEMPERATURE VS. LOCK-IN

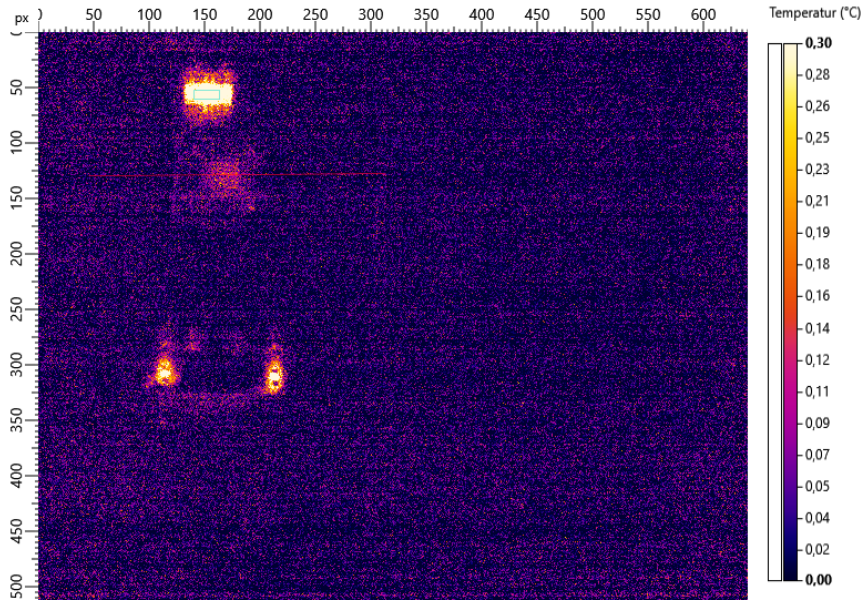


Temperature image.
Overall temperature distribution is visible.



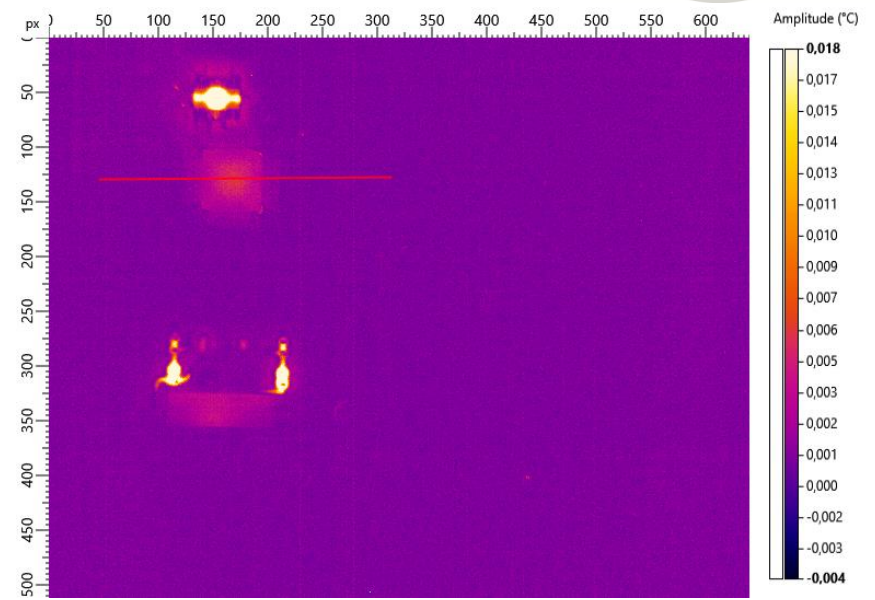
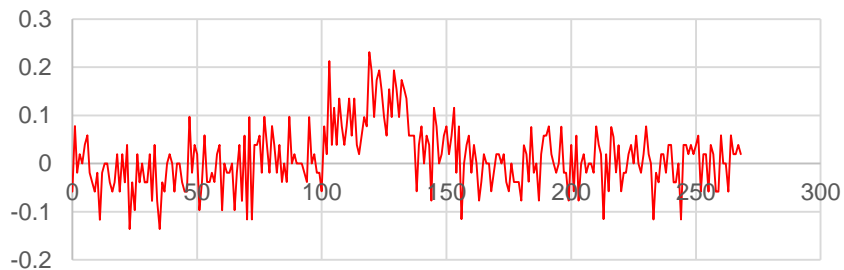
Lock-In Amplitude at 0,5 Hz.
Areas of local dissipation are highlighted selectively.

TEMPERATURE VS. LOCK-IN



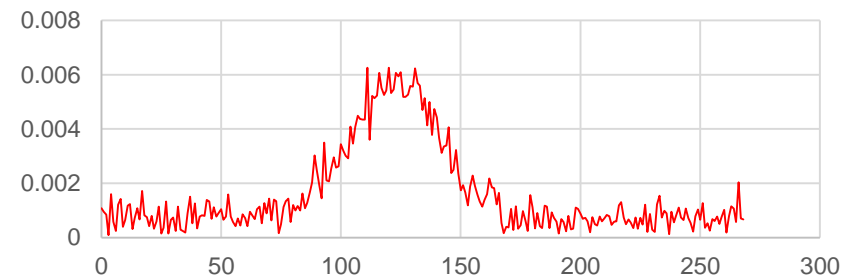
Temperature increase 4s after start of heating

Profile



Lock-In Amplitude at 0,5 Hz.
Measured difference: 6mK

Profile





CONCLUSIONS

- Lockin technique can significantly increase system sensitivity
- Spatial resolution is increased as well due to reduction of thermal diffusion length
- Emissivity effects are suppressed
- Compatible to many existing cameras